



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Features

- $BV_{CEO} > 30V$
- $I_C = 7A$ High Continuous Collector Current
- $I_{CM} = 20A$ Peak Pulse Current
- $P_D = 3W$ Power Dissipation
- Extremely Low Equivalent On-Resistance; $R_{CE(SAT)} = 36\Omega$ at 5A
- Very Low Saturation Voltages
- Complimentary PNP Type FZT949
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

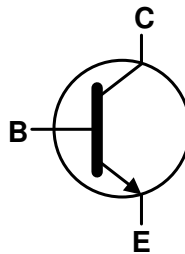
Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic. "Green" Molding Compound; UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads; Solderable per MIL-STD-202, Method 208 
- Weight: 0.112 grams (Approximate)

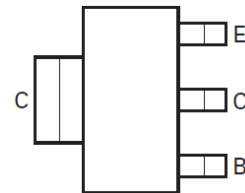
SOT223



Top View



Equivalent Circuit



Top View
Pin-Out

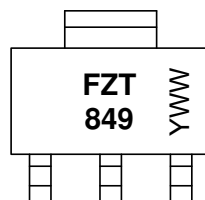
Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
FZT849TA	AEC-Q101	FZT849	7	12	1,000

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information

SOT223



FZT 849 = Product Type Marking Code
YWW = Date Code Marking
Y or $\bar{Y}$ = Last Digit of Year (ex: 6 = 2016)
WW or $\bar{WW}$ = Week Code (01 to 53)

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	80	V
Collector-Emitter Voltage	V _{CEO}	30	V
Emitter-Base Voltage	V _{EBO}	7	V
Continuous Collector Current	I _C	7	A
Peak Pulse Current	I _{CM}	20	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

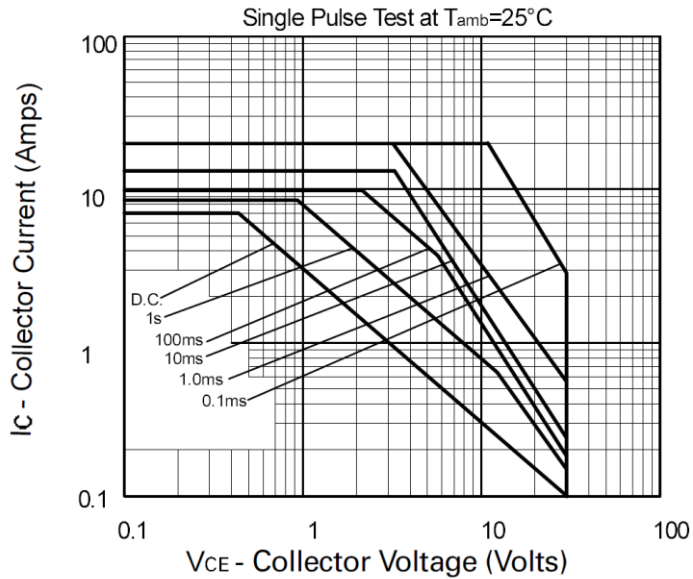
Characteristic	Symbol	Value	Unit
Power Dissipation	P _D	3	W
Linear Derating Factor		24	
		1.6	mW/°C
		12.8	
Thermal Resistance, Junction to Ambient	R _{θJA}	42	°C/W
	R _{θJA}	78	
Thermal Resistance, Junction to Lead	R _{θJL}	8.8	°C
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	

ESD Ratings (Note 8)

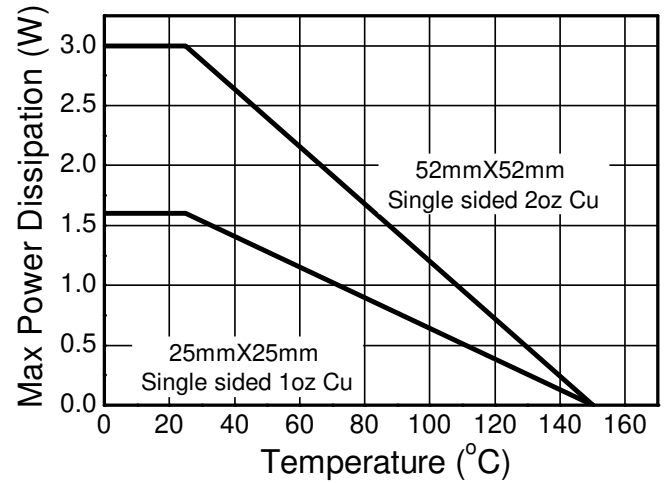
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	C

- Notes:
- For a device mounted with the collector lead on 52mm x 52mm 2oz copper that is on a single-sided 1.6mm FR-4 PCB; device is measured under still air conditions whilst operating in steady-state.
 - Same as Note 5, except the device is mounted on 25mm x 25mm 1oz copper.
 - Thermal resistance from junction to solder-point (at the end of the collector lead).
 - Refer to JEDEC specification JESD22-A114 and JESD22-A115.

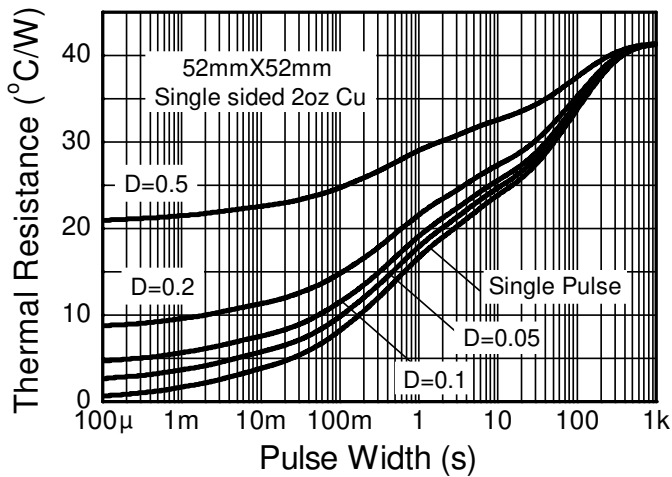
Thermal Characteristics and Derating Information



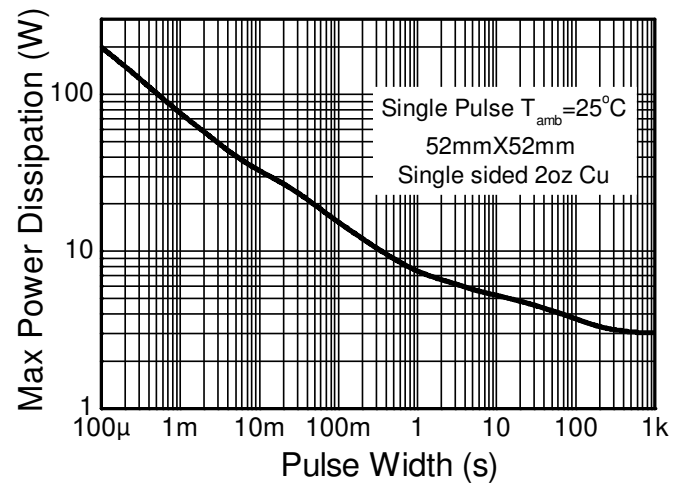
Safe Operating Area



Derating Curve



Transient Thermal Impedance



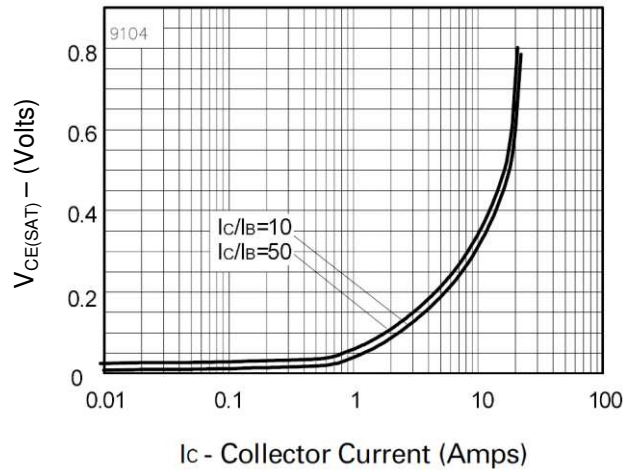
Pulse Power Dissipation

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

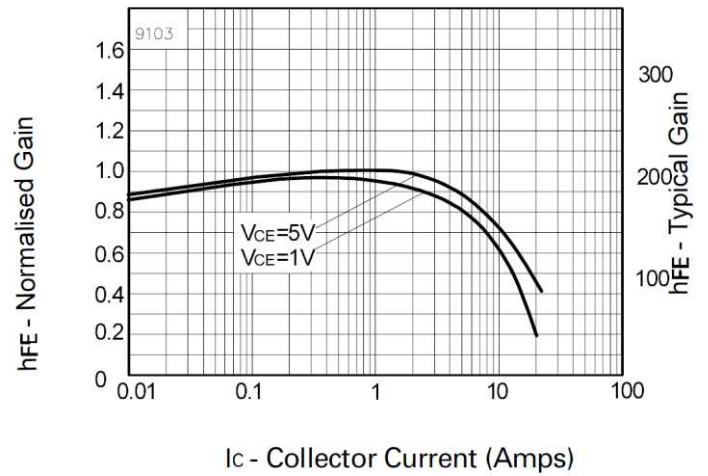
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	80	120	—	V	I _C = 100μA
Collector-Emitter Breakdown Voltage	BV _{CER}	80	120	—	V	I _C = 1μA, R ≤ 1kΩ
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	30	40	—	V	I _C = 10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	6	8	—	V	I _E = 100μA
Collector-Base Cut-Off Current	I _{CBO}	—	—	50 1	nA μA	V _{CB} = 70V V _{CB} = 70V, T _A = +100°C
Collector Cut-Off Current	I _{CER}	—	—	50	nA	V _{CE} = 70V, R ≤ 1kΩ
		—	—	1	μA	V _{CE} = 70V, R ≤ 1kΩ, T _A = +100°C
Emitter Cut-Off Current	I _{EBO}	—	—	10	nA	V _{EB} = 6V
Collector-Emitter Saturation Voltage (Note 9)	V _{CE(SAT)}	—	35 67 188 —	50 110 215 350	mV	I _C = 500mA, I _B = 20mA I _C = 1A, I _B = 20mA I _C = 2A, I _B = 20mA I _C = 6.5A, I _B = 300mA
Base-Emitter Saturation Voltage (Note 9)	V _{BE(SAT)}	—	—	1.2	V	I _C = 6.5A, I _B = 300mA
Base-Emitter Turn-On Voltage (Note 9)	V _{BE(ON)}	—	—	1.13	V	I _C = 6.5A, V _{CE} = 1V
DC Current Gain (Note 9)	h _{FE}	100 100 100 30	200 200 150 65	— 300 — —	—	I _C = 10mA, V _{CE} = 1V I _C = 1A, V _{CE} = 1V I _C = 7A, V _{CE} = 1V I _C = 20A, V _{CE} = 2V
Transitional Frequency	f _T	100	—	—	MHz	I _C = 100mA, V _{CE} = 10V f = 50MHz
Output Capacitance	C _{OBO}	—	75	—	pF	V _{CB} = 10V, f = 1MHz
Switching Time	t _{ON} t _{OFF}	—	45 630	—	ns ns	I _C = 1A, I _{B1} = 100mA I _{B2} = -100mA, V _{CC} = 10V

Note: 9. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

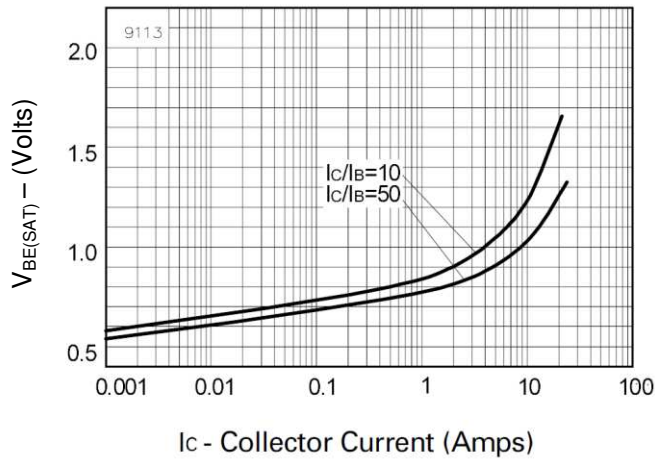
Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



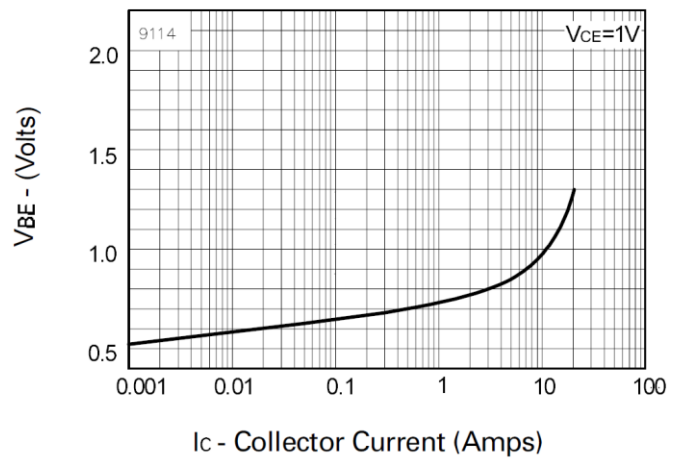
$V_{CE(SAT)}$ v I_C



hFE v I_C



$V_{BE(SAT)}$ v I_C

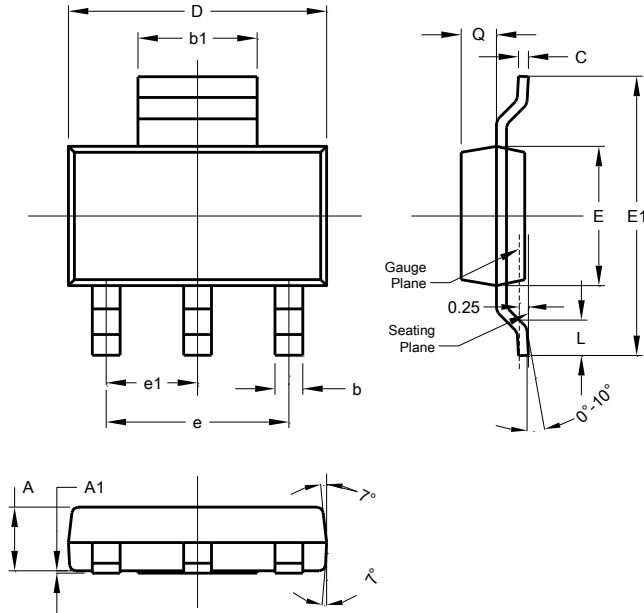


$V_{BE(ON)}$ v I_C

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT223

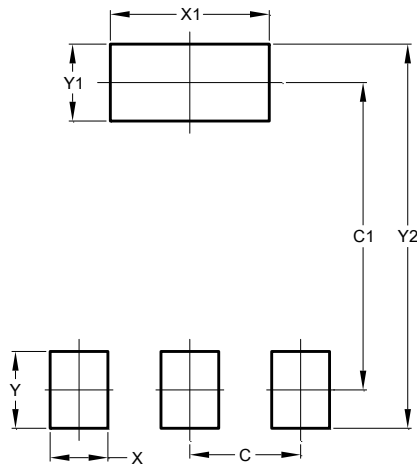


SOT223			
Dim	Min	Max	Typ
A	1.55	1.65	1.60
A1	0.010	0.15	0.05
b	0.60	0.80	0.70
b1	2.90	3.10	3.00
C	0.20	0.30	0.25
D	6.45	6.55	6.50
E	3.45	3.55	3.50
E1	6.90	7.10	7.00
e	-	-	4.60
e1	-	-	2.30
L	0.85	1.05	0.95
Q	0.84	0.94	0.89
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT223



Dimensions	Value (in mm)
C	2.30
C1	6.40
X	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00

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